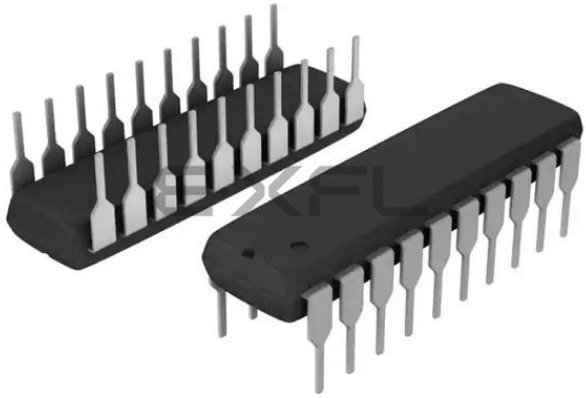

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	ST7
Core Size	8-Bit
Speed	8MHz
Connectivity	SPI
Peripherals	LVD, POR, PWM, WDT
Number of I/O	17
Program Memory Size	2KB (2K x 8)
Program Memory Type	FLASH
EEPROM Size	128 x 8
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 7x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	20-DIP (0.300", 7.62mm)
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/stmicroelectronics/st7flit19bf0b6

3 REGISTER & MEMORY MAP

As shown in Figure 5, the MCU is capable of addressing 64K bytes of memories and I/O registers.

The available memory locations consist of 128 bytes of register locations, 256 bytes of RAM, 128 bytes of data EEPROM and up to 4 Kbytes of flash program memory. The RAM space includes up to 128 bytes for the stack from 180h to 1FFh.

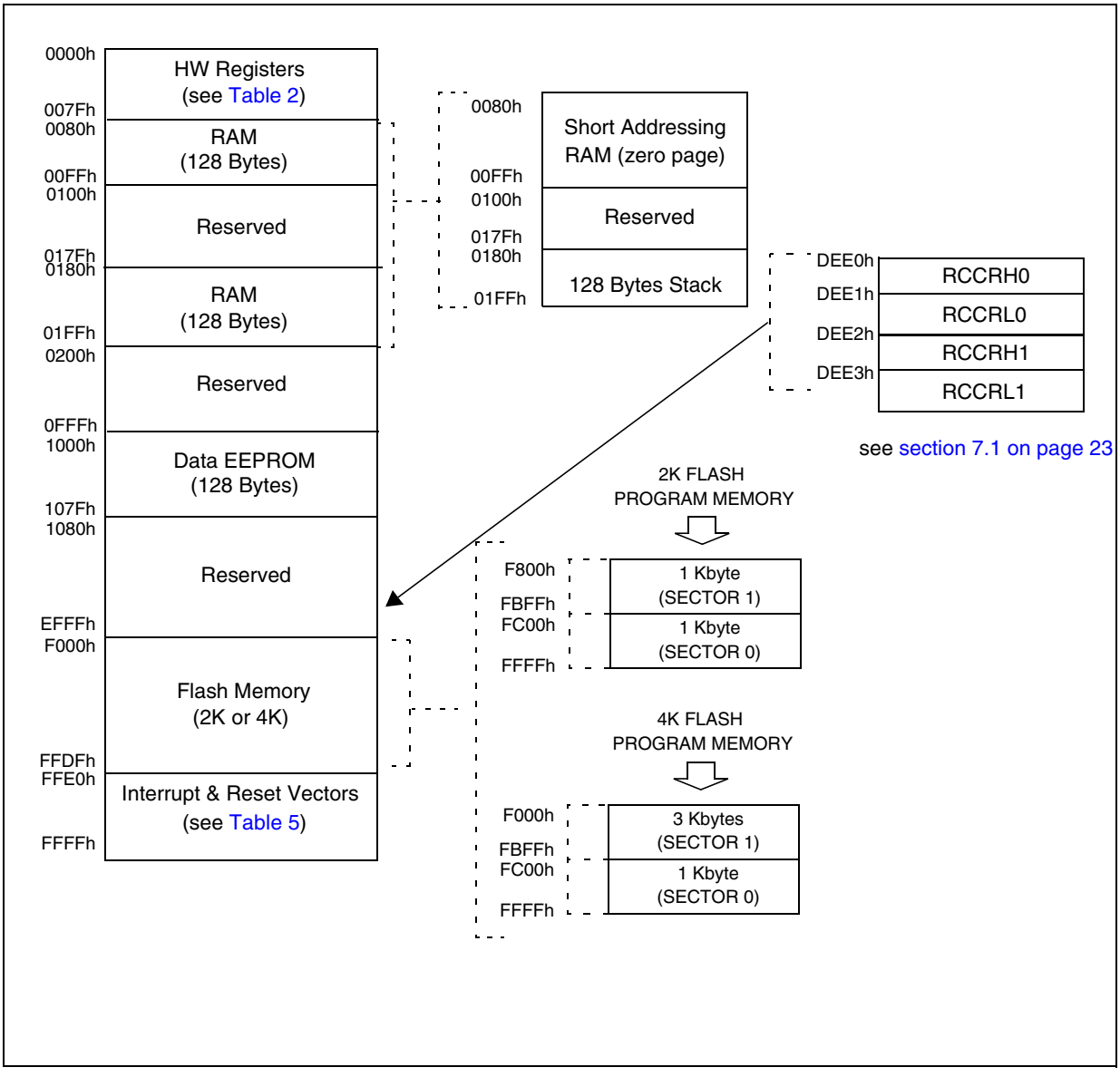
The highest address bytes contain the user reset and interrupt vectors.

The Flash memory contains two sectors (see Figure 5) mapped in the upper part of the ST7 addressing space so the reset and interrupt vectors are located in Sector 0 (F000h-FFFFh).

The size of Flash Sector 0 and other device options are configurable by Option byte (refer to section 15.1 on page 149).

IMPORTANT: Memory locations marked as "Reserved" must never be accessed. Accessing a reserved area can have unpredictable effects on the device.

Figure 5. Memory Map



Address	Block	Register Label	Register Name	Reset Status	Remarks
0002Fh	FLASH	FCSR	Flash Control/Status Register	00h	R/W
00030h	EEPROM	EECSR	Data EEPROM Control/Status Register	00h	R/W
0031h 0032h 0033h	SPI	SPIDR SPICR SPICSR	SPI Data I/O Register SPI Control Register SPI Control Status Register	xxh 0xh 00h	R/W R/W R/W
0034h 0035h 0036h	ADC	ADCCSR ADCDRH ADCDRL	A/D Control Status Register A/D Data Register High A/D Amplifier Control/Data Low Register	00h xxh 0xh	R/W Read Only R/W
0037h	ITC	EICR	External Interrupt Control Register	00h	R/W
0038h	MCC	MCCSR	Main Clock Control/Status Register	00h	R/W
0039h 003Ah	Clock and Reset	RCCR SICSR	RC oscillator Control Register System Integrity Control/Status Register	FFh 0110 0xx0b	R/W R/W
003Bh	PLL clock select	PLLTST	PLL test register	00h	R/W
003Ch	ITC	EISR	External Interrupt Selection Register	0Ch	R/W
003Dh to 0048h	Reserved area (12 bytes)				
0049h 004Ah	AWU	AWUPR AWUCSR	AWU Prescaler Register AWU Control/Status Register	FFh 00h	R/W R/W
004Bh 004Ch 004Dh 004Eh 004Fh 0050h 0051h	DM[3]	DMCR DMSR DMBK1H DMBK1L DMBK2H DMBK2L DMCR2	DM Control Register DM Status Register DM Breakpoint Register 1 High DM Breakpoint Register 1 Low DM Breakpoint Register 2 High DM Breakpoint Register 2 Low DM Control Register 2	00h 00h 00h 00h 00h 00h 00h	R/W R/W R/W R/W R/W R/W R/W
0052h to 007Fh	Reserved area (46 bytes)				

Legend: x=undefined, R/W=read/write

Notes:

1. The contents of the I/O port DR registers are readable only in output configuration. In input configuration, the values of the I/O pins are returned instead of the DR register contents.

2. The bits associated with unavailable pins must always keep their reset value.

3. For a description of the Debug Module registers, see ICC protocol reference manual.

DATA EEPROM (Cont'd)

5.4 POWER SAVING MODES

Wait mode

The DATA EEPROM can enter WAIT mode on execution of the WFI instruction of the microcontroller or when the microcontroller enters Active-HALT mode.The DATA EEPROM will immediately enter this mode if there is no programming in progress, otherwise the DATA EEPROM will finish the cycle and then enter WAIT mode.

Active-Halt mode

Refer to Wait mode.

Halt mode

The DATA EEPROM immediately enters HALT mode if the microcontroller executes the HALT instruction. Therefore the EEPROM will stop the function in progress, and data may be corrupted.

5.5 ACCESS ERROR HANDLING

If a read access occurs while E2LAT=1, then the data bus will not be driven.

If a write access occurs while E2LAT=0, then the data on the bus will not be latched.

If a programming cycle is interrupted (by a RESET action), the integrity of the data in memory will not be guaranteed.

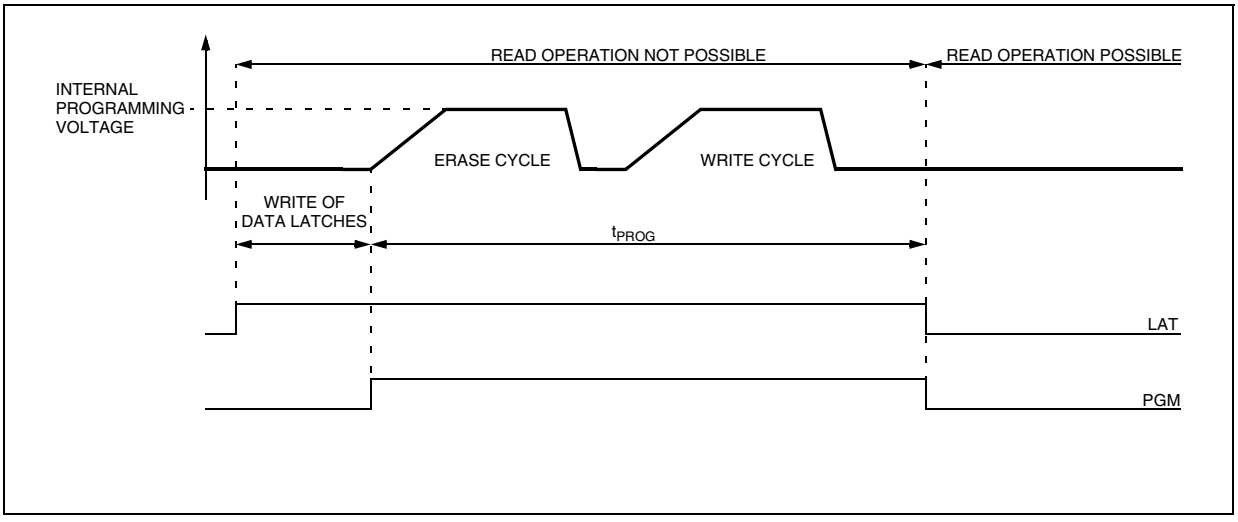
5.6 Data EEPROM Read-out Protection

The read-out protection is enabled through an option bit (see option byte section).

When this option is selected, the programs and data stored in the EEPROM memory are protected against read-out (including a re-write protection). In Flash devices, when this protection is removed by reprogramming the Option Byte, the entire Program memory and EEPROM is first automatically erased.

Note: Both Program Memory and data EEPROM are protected using the same option bit.

Figure 10. Data EEPROM Programming Cycle



SYSTEM INTEGRITY MANAGEMENT (Cont'd)

7.6.4 Register Description

SYSTEM INTEGRITY (SI) CONTROL/STATUS REGISTER (SICSR)

Read/Write

Reset Value: 0110 0xx0 (6xh)

7							0
LOCK 32	CR1	CR0	WDG RF	LOCKED	LVDRF	AVDF	AVDIE

Bit 7 = **LOCK32** *PLL 32Mhz Locked Flag*

This bit is set and cleared by hardware. It is set automatically when the PLL 32Mhz reaches its operating frequency

0: PLL32 not locked

1: PLL32 locked

Bits 6:5 = **CR[1:0]** *RC Oscillator Frequency Adjustment bits*

These bits, as well as CR[9:2] bits in the RCCR register must be written immediately after reset to adjust the RC oscillator frequency and to obtain an accuracy of 1%. Refer to section 7.3 on page 25.

Bit 4 = **WDGRF** *Watchdog Reset flag*
This bit indicates that the last Reset was generated by the Watchdog peripheral. It is set by hardware (watchdog reset) and cleared by software (reading the SICSR register or writing 0 to this bit) or by an LVD Reset (to ensure a stable cleared state of the WDGRF flag when the CPU starts).
Combined with the LVDRF flag information, the flag description is given by the following table.

RESET Sources	LVDRF	WDGRF
External $\overline{\text{RESET}}$ pin	0	0
Watchdog	0	1
LVD	1	X

Bit 3 = **LOCKED** *PLL Locked Flag*
This bit is set and cleared by hardware. It is set automatically when the PLL reaches its operating frequency.
0: PLL not locked
1: PLL locked

Bit 2 = **LVDRF** *LVD reset flag*
This bit indicates that the last Reset was generated by the LVD block. It is set by hardware (LVD reset) and cleared by software (by reading). When the LVD is disabled by OPTION BYTE, the LVDRF bit value is undefined.

Bit 1 = **AVDF** *Voltage Detector Flag*
This read-only bit is set and cleared by hardware. If the AVDIE bit is set, an interrupt request is generated when the AVDF bit is set. Refer to Figure 20 and to Section 7.6.2.1 for additional details.
0: V_{DD} over AVD threshold
1: V_{DD} under AVD threshold

Bit 0 = **AVDIE** *Voltage Detector Interrupt Enable*
This bit is set and cleared by software. It enables an interrupt to be generated when the AVDF flag is set. The pending interrupt information is automatically cleared when software enters the AVD interrupt routine.
0: AVD interrupt disabled
1: AVD interrupt enabled

Application notes

The LVDRF flag is not cleared when another RESET type occurs (external or watchdog), the LVDRF flag remains set to keep trace of the original failure.
In this case, a watchdog reset can be detected by software while an external reset can not.

PLL TEST REGISTER (PLLTST)

Read/Write

Reset Value: 0000 0000 (00h)

7							0
PLLdiv2	0	0	0	0	0	0	0

Bit 7 : **PLLdiv2** *PLL clock divide by 2*

This bit is read or write by software and cleared by hardware after reset. This bit will divide the PLL output clock by 2.
0 : PLL output clock
1 : Divide by 2 of PLL output clock

Refer "Clock Management Block Diagram" on page 26

Note : Write of this bit will be effective after 2 Tcpu cycles (if system clock is 8mhz) else 1 cycle (if system clock is 4mhz) i.e. effective time is 250ns.

Bit 6:0 : Reserved , Must always be cleared

I/O PORTS (Cont'd)

Figure 32. I/O Port General Block Diagram

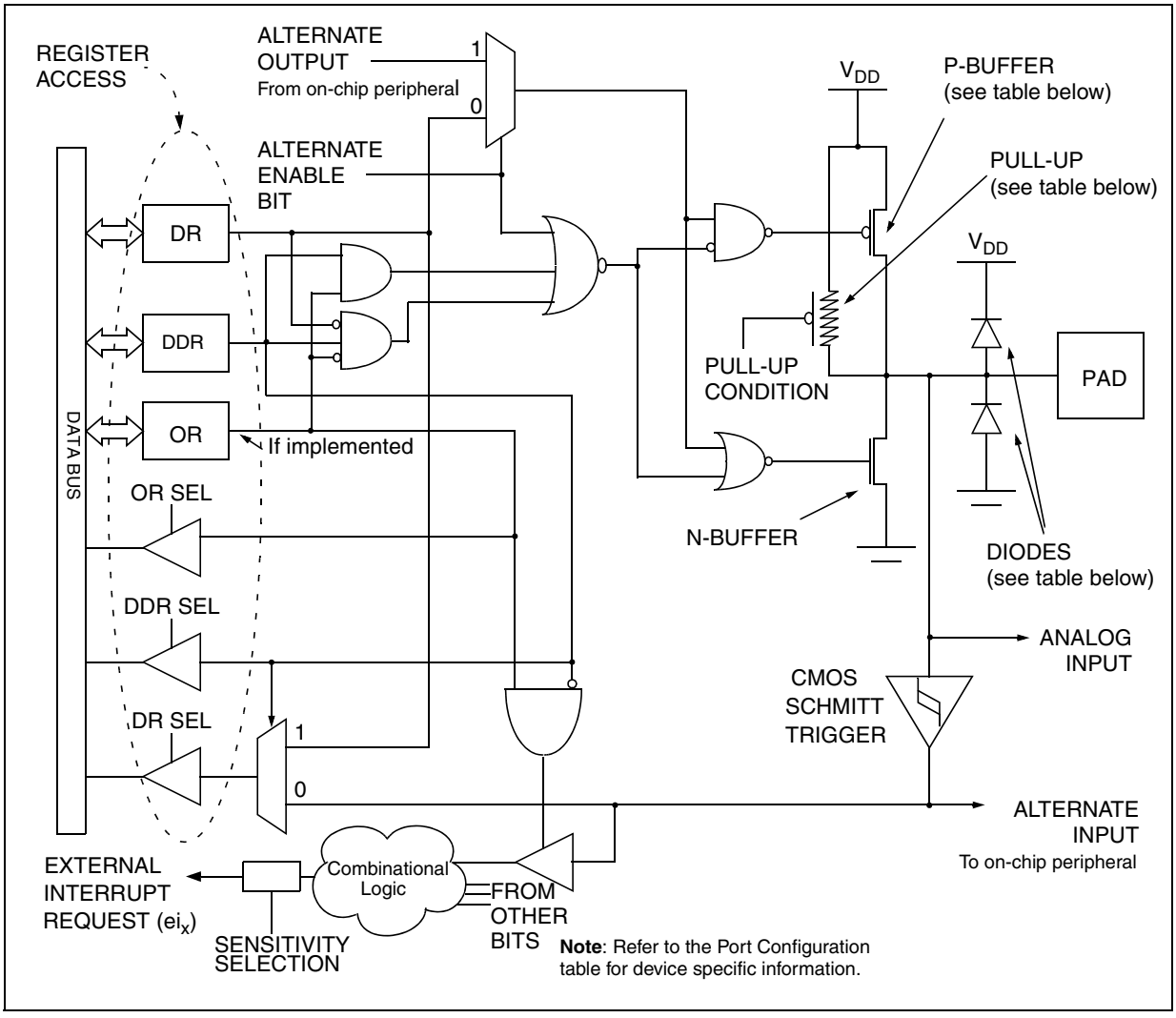


Table 8. I/O Port Mode Options

Configuration Mode		Pull-Up	P-Buffer	Diodes	
				to V_{DD}	to V_{SS}
Input	Floating with/without Interrupt	Off	Off	On	On
	Pull-up with/without Interrupt	On			
Output	Push-pull	Off	On		
	Open Drain (logic level)		Off		

Legend: Off - implemented not activated
On - implemented and activated

DUAL 12-BIT AUTORELOAD TIMER 4 (Cont'd)

Figure 38. PWM Function

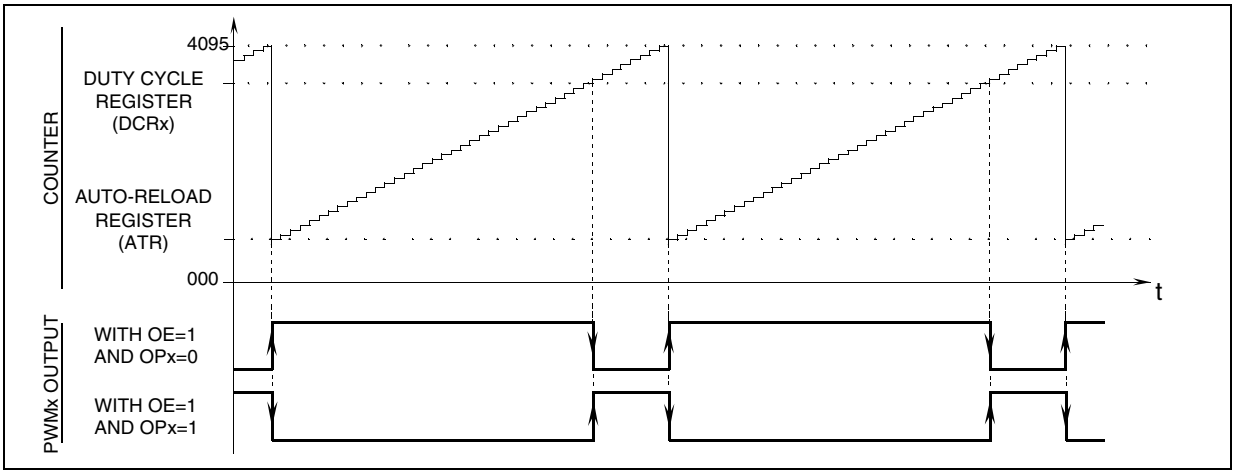


Figure 39. PWM Signal from 0% to 100% Duty Cycle

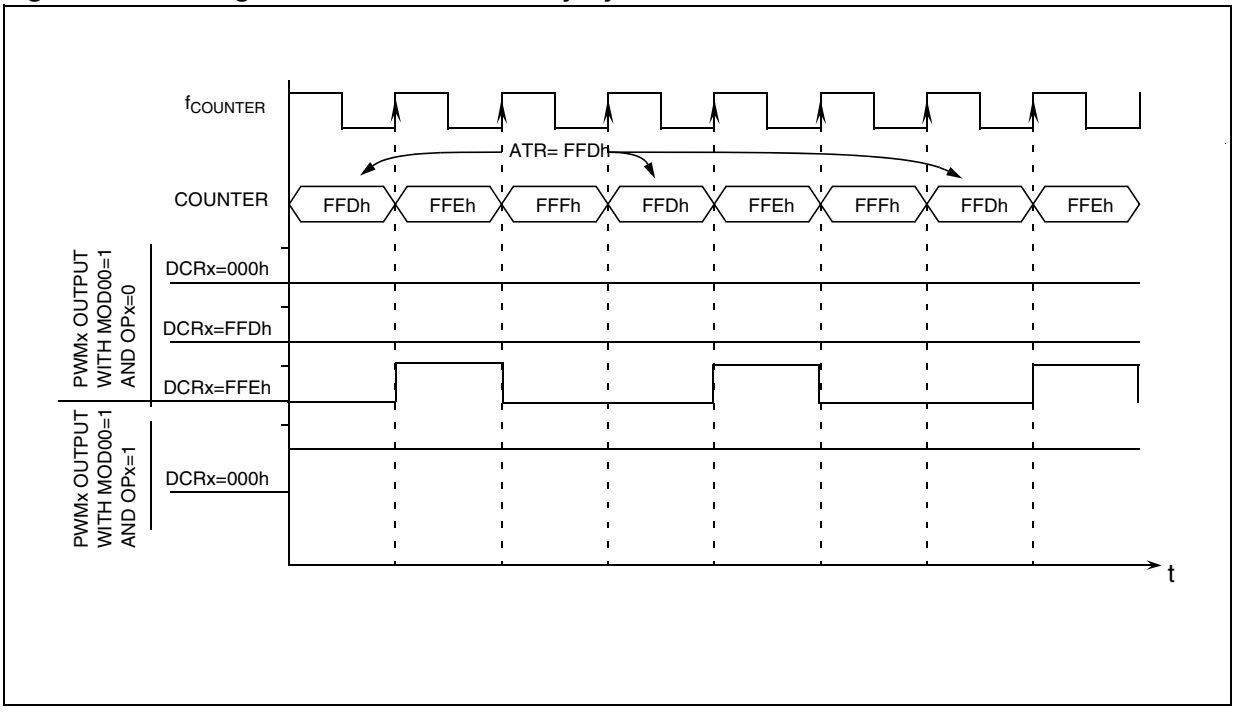
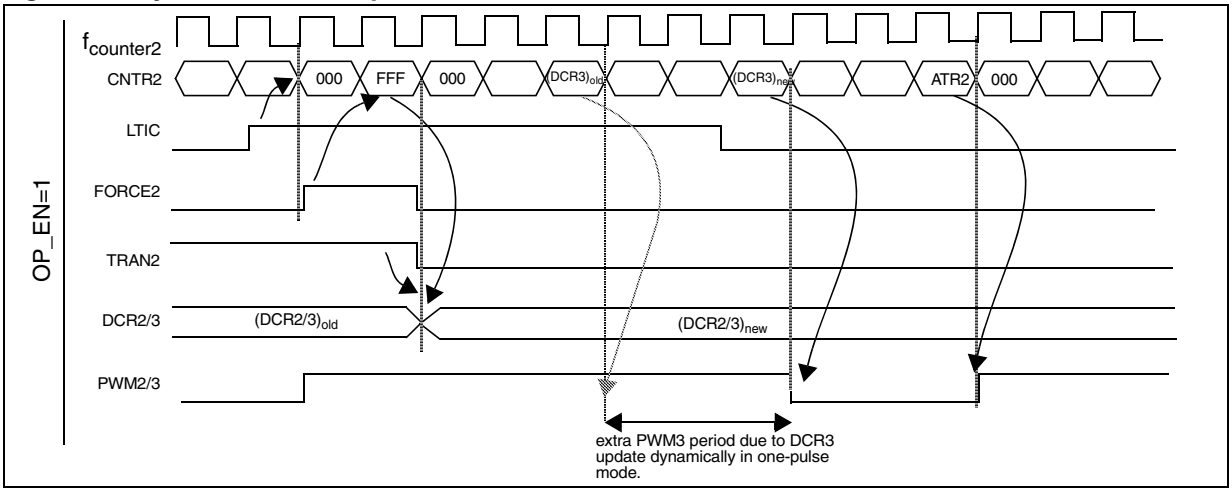


Figure 49. Dynamic DCR2/3 update in One Pulse Mode



Address (Hex.)	Register Label	7	6	5	4	3	2	1	0
21	**ATCSR2**	FORCE2	FORCE1	ICS	OVFIE2	OVF2	ENCNTR2	TRAN2	TRAN1
	Reset Value	0	0	0	0	0	0	1	1
22	**BREAKCR**	BRSEL	BREDGE	BA	BPEN	PWM3	PWM2	PWM1	PWM0
	Reset Value	0	0	0	0	0	0	0	0
23	**ATR2H**	0	0	0	0	ATR11	ATR10	ATR9	ATR8
	Reset Value					0	0	0	0
24	**ATR2L**	ATR7	ATR6	ATR5	ATR4	ATR3	ATR2	ATR1	ATR0
	Reset Value	0	0	0	0	0	0	0	0
25	**DTGR**	DTE	DT6	DT5	DT4	DT3	DT2	DT1	DT0
	Reset Value	0	0	0	0	0	0	0	0
26	**BREAKEN**	0	0	0	0	0	0	BREN2	BREN1
	Reset Value							1	1

LITE TIMER (Cont'd)

11.3.3 Functional Description

11.3.3.1 Timebase Counter 1

The 8-bit value of Counter 1 cannot be read or written by software. After an MCU reset, it starts incrementing from 0 at a frequency of $f_{OSC}/32$. An overflow event occurs when the counter rolls over from F9h to 00h. If f_{OSC} = 8 MHz, then the time period between two counter overflow events is 1 ms. This period can be doubled by setting the TB bit in the LTCSR1 register.

When Counter 1 overflows, the TB1F bit is set by hardware and an interrupt request is generated if the TB1IE bit is set. The TB1F bit is cleared by software reading the LTCSR1 register.

11.3.3.2 Input Capture

The 8-bit input capture register is used to latch the free-running upcounter (Counter 1) 1 after a rising or falling edge is detected on the LTIC pin. When an input capture occurs, the ICF bit is set and the LTICR register contains the counter 1 value. An interrupt is generated if the ICIE bit is set. The ICF bit is cleared by reading the LTICR register.

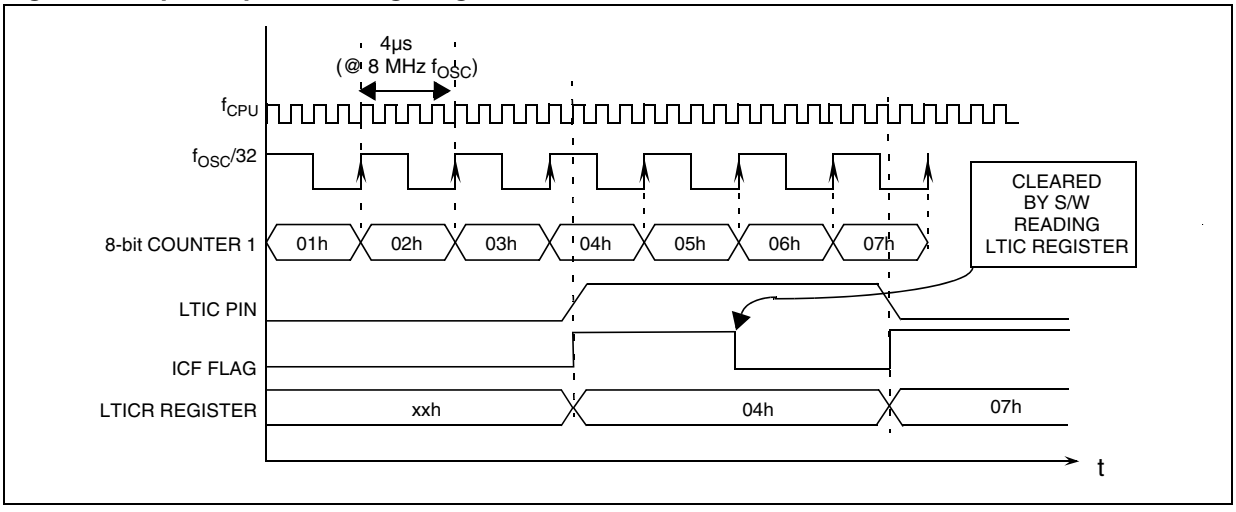
The LTICR is a read-only register and always contains the data from the last input capture. Input capture is inhibited if the ICF bit is set.

11.3.3.3 Timebase Counter 2

Counter 2 is an 8-bit autoreload upcounter. It can be read by accessing the LTCNTR register. After an MCU reset, it increments at a frequency of $f_{OSC}/32$ starting from the value stored in the LTARR register. A counter overflow event occurs when the counter rolls over from FFh to the LTARR reload value. Software can write a new value at any time in the LTARR register, this value will be automatically loaded in the counter when the next overflow occurs.

When Counter 2 overflows, the TB2F bit in the LTCSR2 register is set by hardware and an interrupt request is generated if the TB2IE bit is set. The TB2F bit is cleared by software reading the LTCSR2 register.

Figure 52. Input Capture Timing Diagram.



LITE TIMER (Cont'd)

Bit 6 = **ICF** *Input Capture Flag*
This bit is set by hardware and cleared by software by reading the LTICR register. Writing to this bit does not change the bit value.
0: No input capture
1: An input capture has occurred

Note: After an MCU reset, software must initialize the ICF bit by reading the LTICR register

Bit 5 = **TB** *Timebase period selection*
This bit is set and cleared by software.
0: Timebase period = t_{OSC} * 8000 (1ms @ 8 MHz)
1: Timebase period = t_{OSC} * 16000 (2ms @ 8 MHz)

Bit 4 = **TB1IE** *Timebase Interrupt enable*
This bit is set and cleared by software.
0: Timebase (TB1) interrupt disabled
1: Timebase (TB1) interrupt enabled

Bit 3 = **TB1F** *Timebase Interrupt Flag*
This bit is set by hardware and cleared by software reading the LTCSR register. Writing to this bit has no effect.
0: No counter overflow
1: A counter overflow has occurred

Bits 2:0 = Reserved

LITE TIMER INPUT CAPTURE REGISTER (LTICR)
Read only
Reset Value: 0000 0000 (00h)

7							0
ICR7	ICR6	ICR5	ICR4	ICR3	ICR2	ICR1	ICR0

Bits 7:0 = **ICR[7:0]** *Input Capture Value*
These bits are read by software and cleared by hardware after a reset. If the ICF bit in the LTCSR is cleared, the value of the 8-bit up-counter will be captured when a rising or falling edge occurs on the LTIC pin.

SERIAL PERIPHERAL INTERFACE (cont'd)

11.4.4 Clock Phase and Clock Polarity

Four possible timing relationships may be chosen by software, using the CPOL and CPHA bits (See Figure 5).

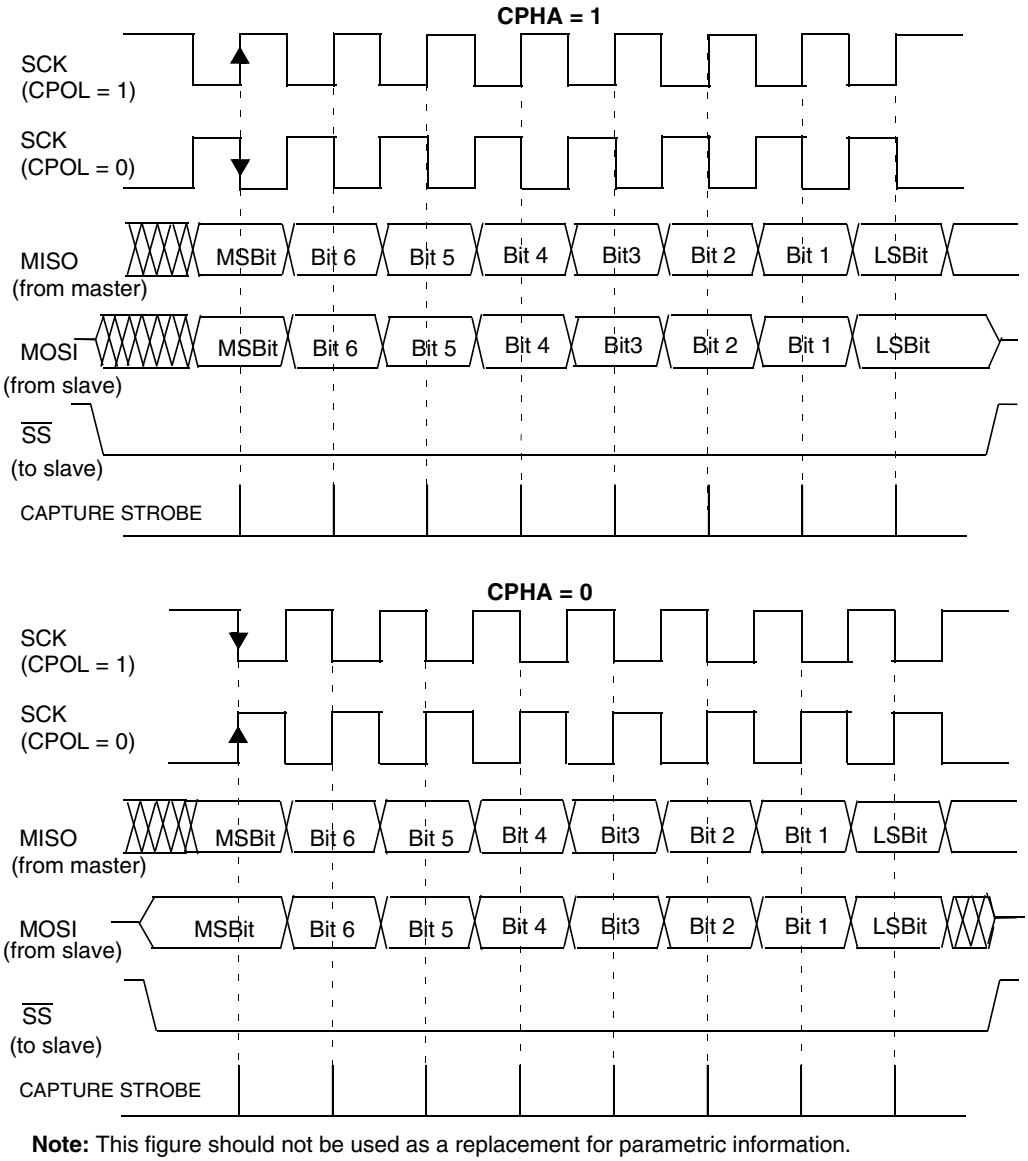
Note: The idle state of SCK must correspond to the polarity selected in the SPICSR register (by pulling up SCK if CPOL = 1 or pulling down SCK if CPOL = 0).

The combination of the CPOL clock polarity and CPHA (clock phase) bits selects the data capture clock edge.

Figure 5 shows an SPI transfer with the four combinations of the CPHA and CPOL bits. The diagram may be interpreted as a master or slave timing diagram where the SCK pin, the MISO pin and the MOSI pin are directly connected between the master and the slave device.

Note: If CPOL is changed at the communication byte boundaries, the SPI must be disabled by resetting the SPE bit.

Figure 57. Data Clock Timing Diagram



Note: This figure should not be used as a replacement for parametric information. Refer to the Electrical Characteristics chapter.

11.4.8 Register Description

SPI CONTROL REGISTER (SPICR)

Read/Write

Reset Value: 0000 xxxx (0xh)

7							0
SPIE	SPE	SPR2	MSTR	CPOL	CPHA	SPR1	SPR0

Bit 7 = **SPIE** *Serial Peripheral Interrupt Enable*
This bit is set and cleared by software.
0: Interrupt is inhibited
1: An SPI interrupt is generated whenever an End of Transfer event, Master Mode Fault or Overrun error occurs (SPIF = 1, MODF = 1 or OVR = 1 in the SPICSR register)

Bit 6 = **SPE** *Serial Peripheral Output Enable*
This bit is set and cleared by software. It is also cleared by hardware when, in master mode, $\overline{SS}$ = 0 (see Section 0.1.5.1 Master Mode Fault (MODF)). The SPE bit is cleared by reset, so the SPI peripheral is not initially connected to the external pins.
0: I/O pins free for general purpose I/O
1: SPI I/O pin alternate functions enabled

Bit 5 = **SPR2** *Divider Enable*
This bit is set and cleared by software and is cleared by reset. It is used with the SPR[1:0] bits to set the baud rate. Refer to Table 1 SPI Master Mode SCK Frequency.
0: Divider by 2 enabled
1: Divider by 2 disabled

Note: This bit has no effect in slave mode.

Bit 4 = **MSTR** *Master Mode*
This bit is set and cleared by software. It is also cleared by hardware when, in master mode, $\overline{SS}$ = 0 (see Section 0.1.5.1 Master Mode Fault (MODF)).
0: Slave mode
1: Master mode. The function of the SCK pin changes from an input to an output and the functions of the MISO and MOSI pins are reversed.

Bit 3 = **CPOL** *Clock Polarity*
This bit is set and cleared by software. This bit determines the idle state of the serial Clock. The CPOL bit affects both the master and slave modes.
0: SCK pin has a low level idle state
1: SCK pin has a high level idle state

Note: If CPOL is changed at the communication byte boundaries, the SPI must be disabled by resetting the SPE bit.

Bit 2 = **CPHA** *Clock Phase*
This bit is set and cleared by software.
0: The first clock transition is the first data capture edge.
1: The second clock transition is the first capture edge.

Note: The slave must have the same CPOL and CPHA settings as the master.

Bits 1:0 = **SPR[1:0]** *Serial Clock Frequency*
These bits are set and cleared by software. Used with the SPR2 bit, they select the baud rate of the SPI serial clock SCK output by the SPI in master mode.

Note: These 2 bits have no effect in slave mode.

Table 16. SPI Master Mode SCK Frequency

Serial Clock	SPR2	SPR1	SPR0
$f_{CPU}/4$	1	0	0
$f_{CPU}/8$	0		
$f_{CPU}/16$			1
$f_{CPU}/32$	1	1	0
$f_{CPU}/64$	0		
$f_{CPU}/128$			1

13.3.4 Auxiliary Voltage Detector (AVD) Thresholds

T_A = -40 to 125°C, unless otherwise specified

Symbol	Parameter	Conditions	Typ	Unit
$V_{IT+(AVD)}$	1=>0 AVDF flag toggle threshold (V_{DD} rise)	High Threshold Med. Threshold Low Threshold	4.50 4.00 3.35	V
$V_{IT-(AVD)}$	0=>1 AVDF flag toggle threshold (V_{DD} fall)	High Threshold Med. Threshold Low Threshold	4.40 3.85 3.20	
V_{hys}	AVD voltage threshold hysteresis	$V_{IT+(AVD)}$-$V_{IT-(AVD)}$	170	mV
ΔV_{IT-}	Voltage drop between AVD flag set and LVD reset activation	V_{DD} fall	0.15	V

13.3.5 Internal RC Oscillator and PLL

The ST7 internal clock can be supplied by an internal RC oscillator and PLL (selectable by option byte).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{DD(RC)}$	Internal RC Oscillator operating voltage	Refer to operating range of V_{DD} with T_A, section 13.3.1 on page 112	2.7		5.5	V
$V_{DD(x4PLL)}$	x4 PLL operating voltage		2.7		3.7	
$V_{DD(x8PLL)}$	x8 PLL operating voltage		3.3		5.5	
$t_{STARTUP}$	PLL Startup time			60		PLL input clock (f_{PLL}) cycles

OPERATING CONDITIONS (Cont'd)

The RC oscillator and PLL characteristics are temperature-dependent and are grouped in four tables.

13.3.5.1 Devices with '"6" or "3"order code suffix (tested for T_A = -40 to +125°C) @ V_{DD} = 5V

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
f_{RC}	Internal RC oscillator frequency [1]	RCCR = FF (reset value), T_A=25°C,V_{DD}=5V		700		kHz
		RCCR = RCCR0[2],T_A=25°C,V_{DD}=5V	992	1000	1008	
ACC_{RC}	Accuracy of Internal RC oscillator with RCCR=RCCR0[2]	T_A=25°C,V_{DD}=5V	-0.8		+0.8	%
		T_A=25°C, V_{DD}=4.5 to 5.5V[3]	-1		+1	%
		T_A=25°C to +85°C,V_{DD}=5V	-3		+3	%
		T_A=25°C to +85°C,V_{DD}=4.5 to 5.5V[3]	-3.5		+3.5	%
		T_A=85°C to +125°C,V_{DD}=5V	-3.5		+5	%
		T_A=85°C to +125°C,V_{DD}=4.5 to 5.5V[3]	-3.5		+6	%
		T_A=-40 to +25°C, V_{DD}=5V[3]	-3		+7	%
$I_{DD(RC)}$	RC oscillator current consumption	T_A=25°C,V_{DD}=5V		600[3]		µA
$t_{su(RC)}$	RC oscillator setup time	T_A=25°C,V_{DD}=5V			10[2]	µs
f_{PLL}	x8 PLL input clock			1[3]		MHz
t_{LOCK}	PLL Lock time[5]			2		ms
t_{STAB}	PLL Stabilization time[5]			4		ms
ACC_{PLL}	x8 PLL Accuracy	f_{RC} = 1MHz@T_A=25°C,V_{DD}=4.5 to 5.5V		0.1[4]		%
		f_{RC} = 1MHz@T_A=-40 to +85°C,V_{DD}=5V		0.1[4]		%
$t_{w(JIT)}$	PLL jitter period [6]	f_{RC} = 1MHz		120		µs
JIT_{PLL}	PLL jitter ($\Delta f_{CPU}/f_{CPU}$)			1[7]		%
$I_{DD(PLL)}$	PLL current consumption	T_A=25°C		600[3]		µA

Notes:

1. If the RC oscillator clock is selected, to improve clock stability and frequency accuracy, it is recommended to place a decoupling capacitor, typically 100nF, between the V_{DD} and V_{SS} pins as close as possible to the ST7 device.

2. See "INTERNAL RC OSCILLATOR ADJUSTMENT" on page 23

3. Data based on characterization results, not tested in production

4. Averaged over a 4ms period. After the LOCKED bit is set, a period of t_{STAB} is required to reach ACC_{PLL} accuracy.

5. After the LOCKED bit is set ACC_{PLL} is max. 10% until t_{STAB} has elapsed. See Figure 13 on page 24.

6. This period is the phase servo loop period. During this period, the frequency remains unchanged.

7. Guaranteed by design.

CLOCK AND TIMING CHARACTERISTICS (Cont'd)

13.5.4 Crystal and Ceramic Resonator Oscillators

The ST7 internal clock can be supplied with ten different Crystal/Ceramic resonator oscillators. All the information given in this paragraph are based on characterization results with specified typical external components. In the application, the resonator and the load capacitors have to be placed as close as possible to the oscillator pins in order to minimize output distortion and start-up stabilization time. Refer to the crystal/ceramic resonator manufacturer for more details (frequency, package, accuracy...).

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
f_{CrOSC}	Crystal Oscillator Frequency		2		16	MHz
C_{L1} C_{L2}	Recommended load capacitance versus equivalent serial resistance of the crystal or ceramic resonator (R_S)		See table below			pF

Supplier	f_{CrOSC} (MHz)	Typical Ceramic Resonators[1]		CL1 [3] [pF]	CL2 [3] [pF]	Rd [Ω]	Supply Voltage Range [V]	Temperature Range [°C]
		Type[2]	Reference					
Murata	1	SMD	CSBFB1M00J58-R0	220	*220*	2.2k	3.3V to 5.5V	-40 to 85
		LEAD	CSBLA1M00J58-B0	220	220	2.2k		
	2	SMD	CSTCC2M00G56Z-R0	(47)	(47)	0	3.0V to 5.5V	
	4	SMD	CSTCR4M00G53Z-R0	(15)	(15)	0		
		LEAD	CSTLS4M00G53Z-B0	(15)	(15)	0		
	8	SMD	CSTCE8M00G52Z-R0	(10)	(10)	0		
		LEAD	CSTLS8M00G53Z-B0	(15)	(15)	0		
	12	SMD	CSTCE12M0G52Z-R0	(10)	(10)	0	3.3V to 5.5V	
	16	SMD	CSTCE16M0V51Z-R0	(5)	(5)	0		
		LEAD	CSTLS16M0X51Z-B0	(5)	(5)	0		

Notes:

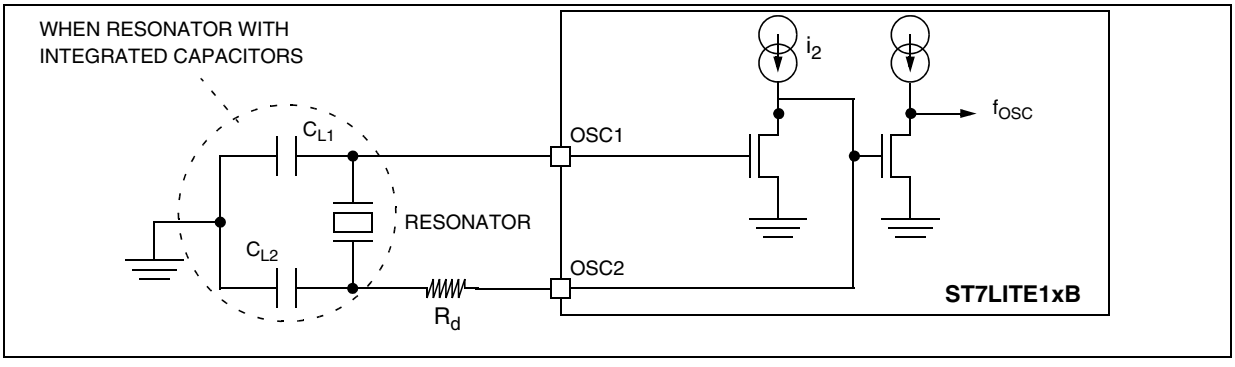
1. Resonator characteristics given by the ceramic resonator manufacturer. For more information on these resonators, please consult www.murata.com

2. SMD = [-R0: Plastic tape package (∅ =180mm)]

LEAD = [-B0: Bulk]

3. () means load capacitor built in resonator

Figure 79. Typical Application with a Crystal or Ceramic Resonator



13.6 MEMORY CHARACTERISTICS

T_A = -40°C to 125°C, unless otherwise specified

13.6.1 RAM and Hardware Registers

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{RM}	Data retention mode [1]	HALT mode (or RESET)	1.6			V

13.6.2 FLASH Program Memory

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{DD}	Operating voltage for Flash write/erase	Refer to operating range of V_{DD} with T_A, section 13.3.1 on page 112	2.7		5.5	V
t_{prog}	Programming time for 1~32 bytes [2]	T_A=–40 to +125°C		5	10	ms
	Programming time for 1.5 kBytes	T_A=+25°C		0.24	0.48	s
t_{RET}	Data retention [4]	T_A=+55°C[3]	20			years
N_{RW}	Write erase cycles	T_A=+25°C	10K			cycles
I_{DD}	Supply current [6]	Read / Write / Erase modes f_{CPU} = 8MHz, V_{DD} = 5.5V			2.6	mA
		No Read/No Write Mode			100	µA
		Power down mode / HALT		0	0.1	µA

13.6.3 EEPROM Data Memory

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
V_{DD}	Operating voltage for EEPROM write/erase	Refer to operating range of V_{DD} with T_A, section 13.3.1 on page 112	2.7		5.5	V
t_{prog}	Programming time for 1~32 bytes	T_A=–40 to +125°C		5	10	ms
t_{ret}	Data retention [4]	T_A=+55°C [3]	20			years
N_{RW}	Write erase cycles	T_A=+25°C	300K			cycles

Notes:

1. Minimum V_{DD} supply voltage without losing data stored in RAM (in HALT mode or under RESET) or in hardware registers (only in HALT mode). Guaranteed by construction, not tested in production.

2. Up to 32 bytes can be programmed at a time.

3. The data retention time increases when the T_A decreases.

4. Data based on reliability test results and monitored in production.

5. Data based on characterization results, not tested in production.

6. Guaranteed by Design. Not tested in production.

CONTROL PIN CHARACTERISTICS (Cont'd)

Figure 105. $\overline{\text{RESET}}$ pin protection when LVD is enabled.[1)2)3)4)]

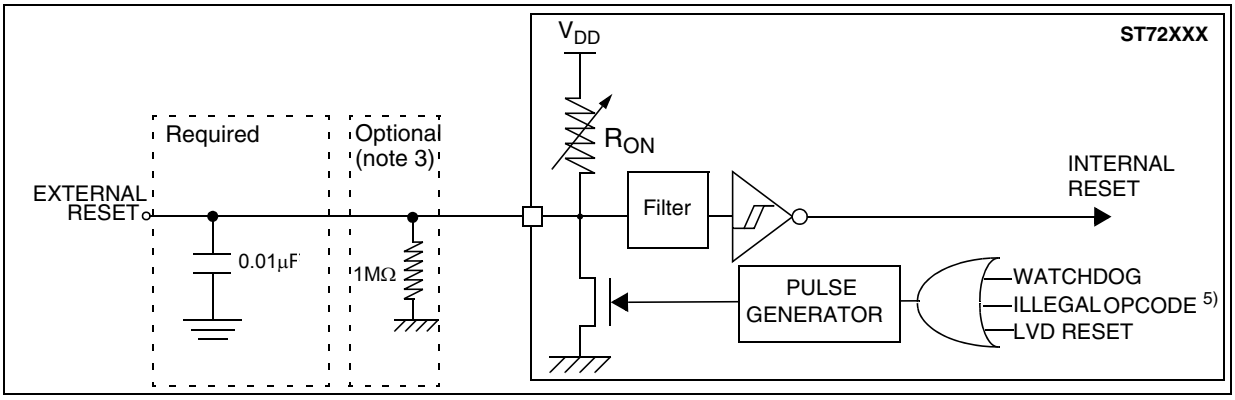
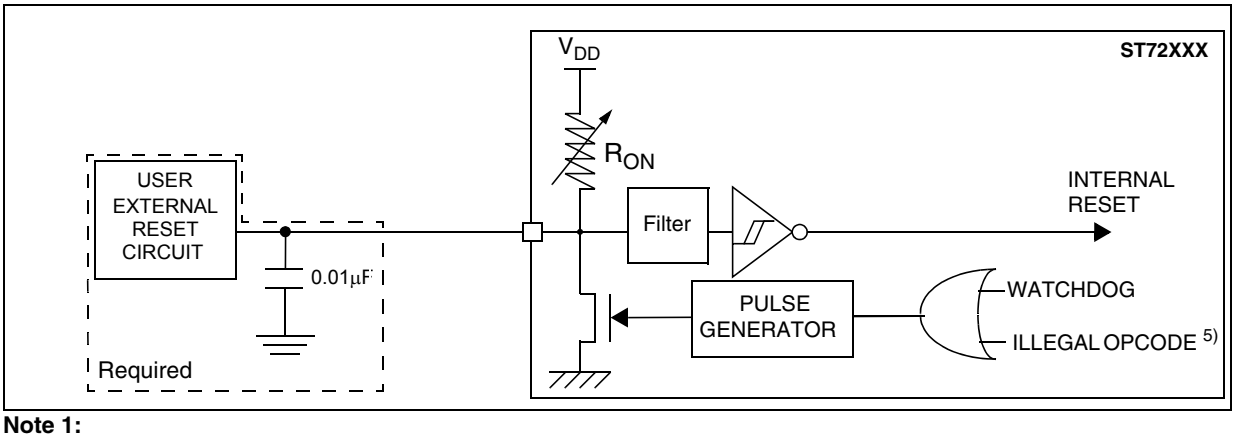


Figure 106. $\overline{\text{RESET}}$ pin protection when LVD is disabled.[1)]



Note 1:

- The reset network protects the device against parasitic resets.
- The output of the external reset circuit must have an open-drain output to drive the ST7 reset pad. Otherwise the device can be damaged when the ST7 generates an internal reset (LVD or watchdog).
- Whatever the reset source is (internal or external), the user must ensure that the level on the $\overline{\text{RESET}}$ pin can go below the V_{IL} max. level specified in section 13.9.1 on page 135. Otherwise the reset will not be taken into account internally.
- Because the reset circuit is designed to allow the internal RESET to be output in the $\overline{\text{RESET}}$ pin, the user must ensure that the current sunk on the $\overline{\text{RESET}}$ pin is less than the absolute maximum value specified for $I_{INJ(RESET)}$ in section 13.2.2 on page 111.

Note 2: When the LVD is enabled, it is recommended not to connect a pull-up resistor or capacitor. A 10nF pull-down capacitor is required to filter noise on the reset line.

Note 3: In case a capacitive power supply is used, it is recommended to connect a 1MΩ pull-down resistor to the $\overline{\text{RESET}}$ pin to discharge any residual voltage induced by the capacitive effect of the power supply (this will add 5µA to the power consumption of the MCU).

Note 4: Tips when using the LVD:

- 1. Check that all recommendations related to ICCCLK and reset circuit have been applied (see caution in Table 1 on page 7 and notes above)
- 2. Check that the power supply is properly decoupled (100nF + 10µF close to the MCU). Refer to AN1709 and AN2017. If this cannot be done, it is recommended to put a 100nF + 1MΩ pull-down on the $\overline{\text{RESET}}$ pin.
- 3. The capacitors connected on the RESET pin and also the power supply are key to avoid any start-up marginality. In most cases, steps 1 and 2 above are sufficient for a robust solution. Otherwise: replace 10nF pull-down on the $\overline{\text{RESET}}$ pin with a 5µF to 20µF capacitor."

Note 5: Please refer to "Illegal Opcode Reset" on page 107 for more details on illegal opcode reset conditions.

14.2 SOLDERING INFORMATION

In accordance with the RoHS European directive, all STMicroelectronics packages have been converted to lead-free technology, named ECOPACK™.

- ECOPACK™ packages are qualified according to the JEDEC STD-020C compliant soldering profile.
- Detailed information on the STMicroelectronics ECOPACK™ transition program is available on www.st.com/stonline/leadfree/, with specific technical Application notes covering the main technical aspects related to lead-free conversion (AN2033, AN2034, AN2035, AN2036).

Backward and forward compatibility:

The main difference between Pb and Pb-free soldering process is the temperature range.

– ECOPACK™ TQFP, SDIP, SO and QFN20 packages are fully compatible with Lead (Pb) containing soldering process (see application note AN2034)

– TQFP, SDIP and SO Pb-packages are compatible with Lead-free soldering process, nevertheless it's the customer's duty to verify that the Pb-packages maximum temperature (mentioned on the Inner box label) is compatible with their Lead-free soldering temperature.

Table 25. Soldering Compatibility (wave and reflow soldering process)

Package	Plating material devices	Pb solder paste	Pb-free solder paste
SDIP & PDIP	Sn (pure Tin)	Yes	Yes *
QFN	Sn (pure Tin)	Yes	Yes *
TQFP and SO	NiPdAu (Nickel-palladium-Gold)	Yes	Yes *

* Assemblers must verify that the Pb-package maximum temperature (mentioned on the Inner box label) is compatible with their Lead-free soldering process.

15 DEVICE CONFIGURATION AND ORDERING INFORMATION

Each device is available for production in user programmable versions (FLASH).

ST7FLITE1xB devices are shipped to customers with a default program memory content (FFh). This implies that FLASH devices have to be configured by the customer using the Option Bytes.

15.1 OPTION BYTES

The two option bytes allow the hardware configuration of the microcontroller to be selected.

The option bytes can be accessed only in programming mode (for example using a standard ST7 programming tool).

OPTION BYTE 0

OPT7 = Reserved, must always be 1.

OPT6 = **PKG** *Package selection*
0: 16-pin package
1: 20-pin package

OPT5:4 = **CLKSEL** *Clock Source Selection*
When the internal RC oscillator is not selected (Option OSC=1), these option bits select the clock source: resonator oscillator or external clock

Clock Source		Port C	CLKSEL	
Resonator		Ext. Osc Disabled/ Port C Enabled	0	0
Ext. Clock source: CLKIN	on PB4	Ext. Osc Enabled/ Port C Disabled	0	1
	on PC0		1	1
Reserved			1	0

Note: When the internal RC oscillator is selected, the CLKSEL option bits must be kept at their default value in order to select the 256 clock cycle delay (see Section 7.5).

OPT3:2 = **SEC[1:0]** *Sector 0 size definition*
These option bits indicate the size of sector 0 according to the following table.

Sector 0 Size	SEC1	SEC0
0.5k	0	0
1k	0	1
2k	1	0
4k	1	1

OPT1 = **FMP_R** *Read-out protection*
Readout protection, when selected provides a protection against program memory content extraction and against write access to Flash memory. Erasing the option bytes when the FMP_R option is selected will cause the whole memory to be erased first and the device can be reprogrammed. Refer to the ST7 Flash Programming Reference Manual and section 4.5 on page 14 for more details
0: Read-out protection off
1: Read-out protection on

OPT0 = **FMP_W** *FLASH write protection*
This option indicates if the FLASH program memory is write protected.
Warning: When this option is selected, the program memory (and the option bit itself) can never be erased or programmed again.
0: Write protection off
1: Write protection on

	OPTION BYTE 0								OPTION BYTE 1							
	7							0	7							0
	Res.	PKG	CLKSEL		SEC1	SEC0	FMP R	FMP W	PLL x4x8	PLL OFF	PLL32 OFF	OSC	LVD1	LVD0	WDG SW	WDG HALT
Default Value	1	1	1	1	0	1	0	0	1	1	1	0	1	1	1	1

15.3 DEVELOPMENT TOOLS

Development tools for the ST7 microcontrollers include a complete range of hardware systems and software tools from STMicroelectronics and third-party tool suppliers. The range of tools includes solutions to help you evaluate microcontroller peripherals, develop and debug your application, and program your microcontrollers.

15.3.1 Starter kits

ST offers complete, affordable **starter kits**. Starter kits are complete hardware/software tool packages that include features and samples to help you quickly start developing your application.

15.3.2 Development and debugging tools

Application development for ST7 is supported by fully optimizing **C Compilers** and the **ST7 Assembler-Linker** toolchain, which are all seamlessly integrated in the ST7 integrated development environments in order to facilitate the debugging and fine-tuning of your application. The Cosmic C Compiler is available in a free version that outputs up to 16KBytes of code.

The range of hardware tools includes full-featured **ST7-EMU3 series emulators**, cost effective **ST7-DVP3 series emulators** and the low-cost **RLink** in-circuit debugger/programmer. These tools are supported by the **ST7 Toolset** from STMicroelectronics, which includes the STVD7 integrated development environment (IDE) with high-level language debugger, editor, project manager and integrated programming interface.

15.3.3 Programming tools

During the development cycle, the **ST7-DVP3** and and **ST7-EMU3 series emulators** and the **RLink** provide in-circuit programming capability for programming the Flash microcontroller on your application board.

ST also provides a low-cost dedicated in-circuit programmer, the **ST7-STICK**, as well as **ST7 Socket Boards** which provide all the sockets required for programming any of the devices in a specific ST7 sub-family on a platform that can be used with any tool with in-circuit programming capability for ST7.

For production programming of ST7 devices, ST's third-party tool partners also provide a complete range of gang and automated programming solutions, which are ready to integrate into your production environment.

15.3.4 Order Codes for Development and Programming Tools

Table 28 below lists the ordering codes for the ST7LITE1xB development and programming tools. For additional ordering codes for spare parts and accessories, refer to the online product selector at www.st.com/mcu.

15.3.5 Order codes for ST7LITE1xB development tools

Table 28. Development tool order codes for the ST7LITE1xB family

MCU	In-circuit Debugger, RLink Series[1]		Emulator		Programming Tool	
	Starter Kit without Demo Board	Starter Kit with Demo Board	DVP Series	EMU Series	In-circuit Programmer	ST Socket Boards and EPBs
ST7FLIT1xBF0 ST7FLIT1xBF1 ST7FLIT1xBY0 ST7FLIT1xBY1	STX-RLINK[2]	ST7FLITE-SK/RAIS[2]	ST7MDT10-DVP3[4]	ST7MDT10-EMU3	STX-RLINK ST7-STICK[3][5]	ST7SB10-123[3]

Notes:

1. Available from ST or from Raisonance, www.raisonance.com
2. USB connection to PC
3. Add suffix /EU, /UK or /US for the power supply for your region
4. Includes connection kit for DIP16/SO16 only. See "How to order an EMU or DVP" in ST product and tool selection guide for connection kit ordering information
5. Parallel port connection to PC